

NALU SCIENTIFIC  
ENABLING INNOVATION

## Design and Fabrication of the HDSoc- High Density Digitizer System-on-Chip

A High channel-density Waveform Digitizer for direct interfacing of optical sensors Application Specific Integrated Circuit (ASIC).

**Aug 16, 2023**

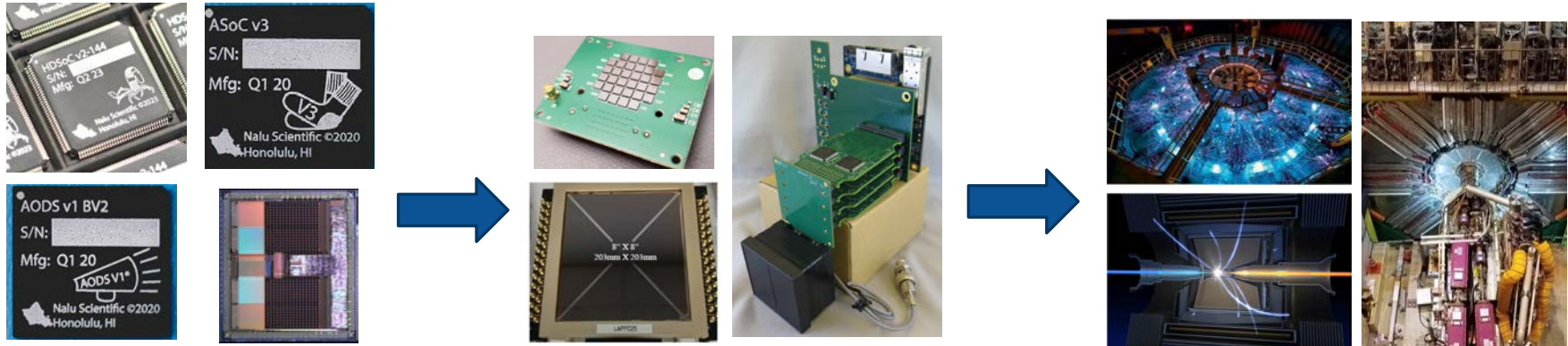
**Luca Macchiarulo, Ph.D.**

**Senior Engineer at Nalu Scientific LLC**

Work funded by DE-SC0020457

NCE: 12/31/23

# Core Technology: Data Acquisition Microchips



## 1. Front-end Chips:

- Event based digitizer+DSP
- 4-32 channel scope on chip
- 1-15 Gsa/s, 12 bit res.
- Low SWaP-C
- User friendly: FW/SW tools

## 2. Integration:

- SiPM
- PMT
- LAPPD
- Detector arrays

## 3. Applications:

- NP/HEP experiments
- Astro particle physics
- Beam Diagnostics
- Plasma/fusion diagnostics
- Lidar
- PET imaging

# ABOUT NALU SCIENTIFIC

## Agile Small Business in Honolulu, Hawai'i

Located at the Manoa Innovation Center near U. of Hawaii

20 staff members: 7 PhDs, 5 MSc, 8 BSc

Access to advanced design tools

Rapid design, prototyping and testing

## Vertically Integrated Team:

Microelectronics

Analog + digital System-on-Chip (SoC)

Hardware

Complex multi-layer PCBs

Firmware

FPGAs, CPUs, Embedded

Software

Data science, GUI, documentation

Scientific

Plasma, medical, physicists, space

## Exclusive Distributor Agreement for North America

Sales of ASICs, eval boards

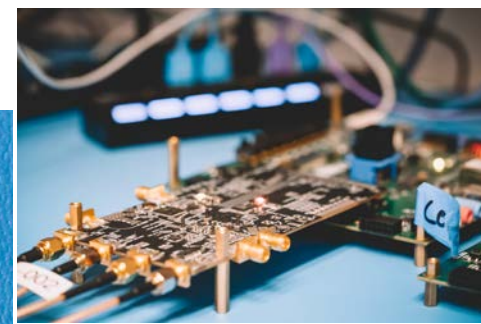
Enhanced OEM opportunities

 **CAEN** Technologies Inc.

Nalu = 'wave' in native Hawaiian language

# Current ASIC Projects

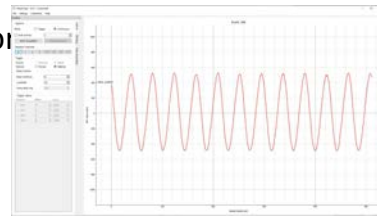
Project	Sampling (GHz)	BW (GHz)	Buffer (Samples)	Number of Channels	Timing Res. (ps)	Available Date
ASoC	3-5	0.8	16k	4	35	Rev 3 avail
HDSoC	1-2	0.6	2k	32	80-120	Rev 1 avail
AARDVARC	8-14	2.2	16k	8	10	Rev 4 avail
AODS	1-2	1	8k	1-4	100-200	Rev 2 avail
UDC	8-10	1.5	4k	16	10	Rev 1 avail



Microchips



Eval PCB



Software

- DOE Phase I/II SBIRs
- Low SWaP-C specialty digitizers for
  - Radiation detection
  - Photonic sensors
  - Time of Flight (ToF)
  - Medical imaging
  - Space
  - Rad hard and harsh
- Evaluation PCBs available
- Extensive suite of software tools
- All microchips and tools available through CAEN Technologies USA

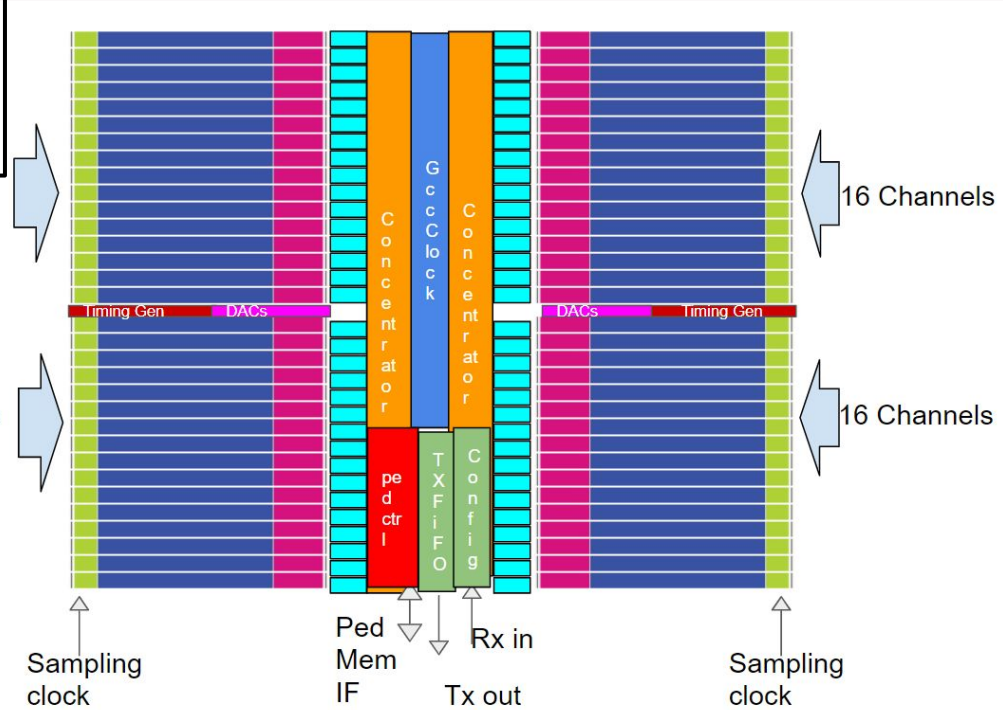
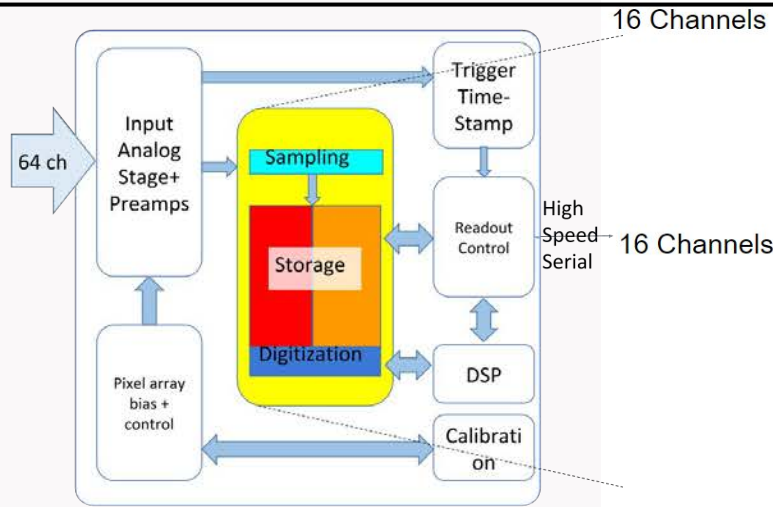
# HDSoc project - Summary

- Part I:
  - Topic Introduction - The need
  - HDSoc concept
  - Rev. 1 design and Fabrication
- Part II:
  - Rev. 1 testing fixtures
  - Rev. 1 initial evaluation
  - Rev. 1 extensive testing
- Part III:
  - Rev. 2 Design
  - Rev. 2 Fabrication
  - Packaging and testing

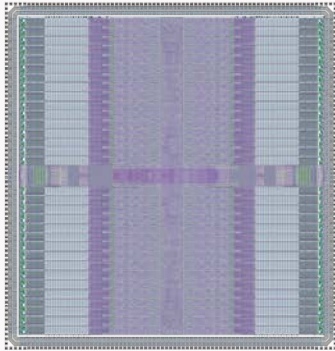
Part I:  
High Density Digitizer SoC - concept  
and Design

# 64-Channel HDSoc Block Diagram

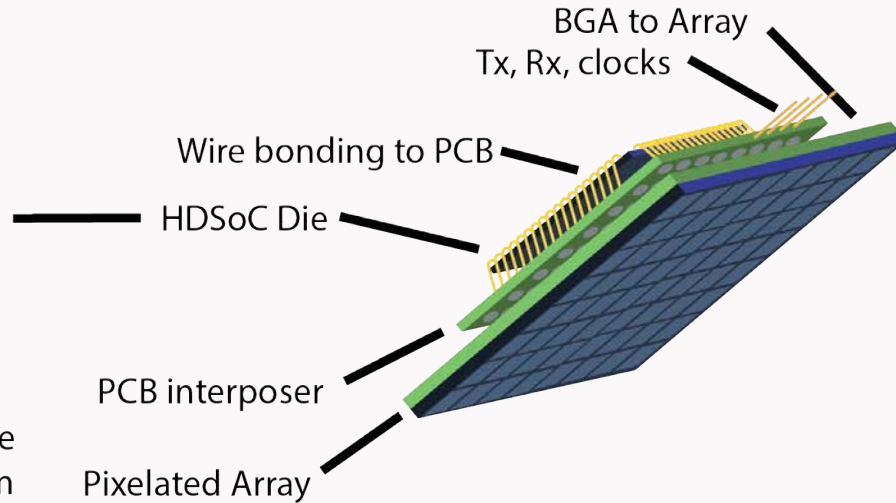
*"HDSoc": High channel count ASIC with full waveform sampling and data reduction, targeting the increase of readout integration for very high-density detectors such as Silicon PhotoMultipliers (SiPM), MA-PMTs, and LAPPDs - low-cost, low power, solution for experiments with very large channel counts.*



# 64-Channel HDSoC concept



Nalu Scientific  
HDSoC V1 64 channel estimate  
64 channel = 7.2 mm x 7.4 mm







# HDSoC DESIGN CONCEPT DETAILS

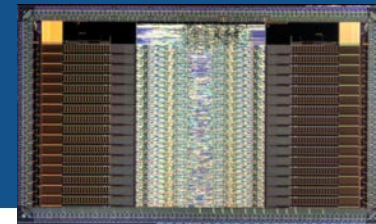
## High density waveform digitizer

- High Density: 64 channels (V1:32, V2:64)
- Full waveform sampler and digitizer
- Highly integrated, SiPM gain + bias
- Commercially available, low cost CMOS

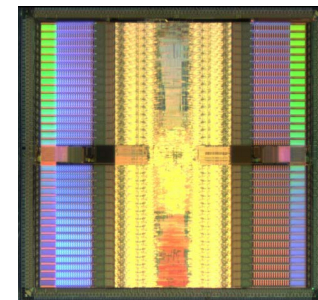
Parameter	Target Spec
Sampling Rate	1-2 GSps
ABW	> 600MHz
Depth	2k Sa
Trigger Buffer	~2 us (@1Gsps)
Deadtime	0**
Channels	32/64
Supply/Range	2.5
ADC bits	12
Timing accuracy	80-120ps
Technology	250 nm CMOS
Power	20-45mW/ch

- On chip TIA
- Serial interface (up to 500 Gsps)
- Discriminator for self-triggering and zero suppression - exported in dedicated serial stream
- Virtually dead-timeless (buffer virtualization)
- Feature Extraction
- 32 ch and 64 ch proto chips fabricated
- Phase II SBIR almost complete

\*\*If average rates compatible with maximum limits - currently 220kEvents/second

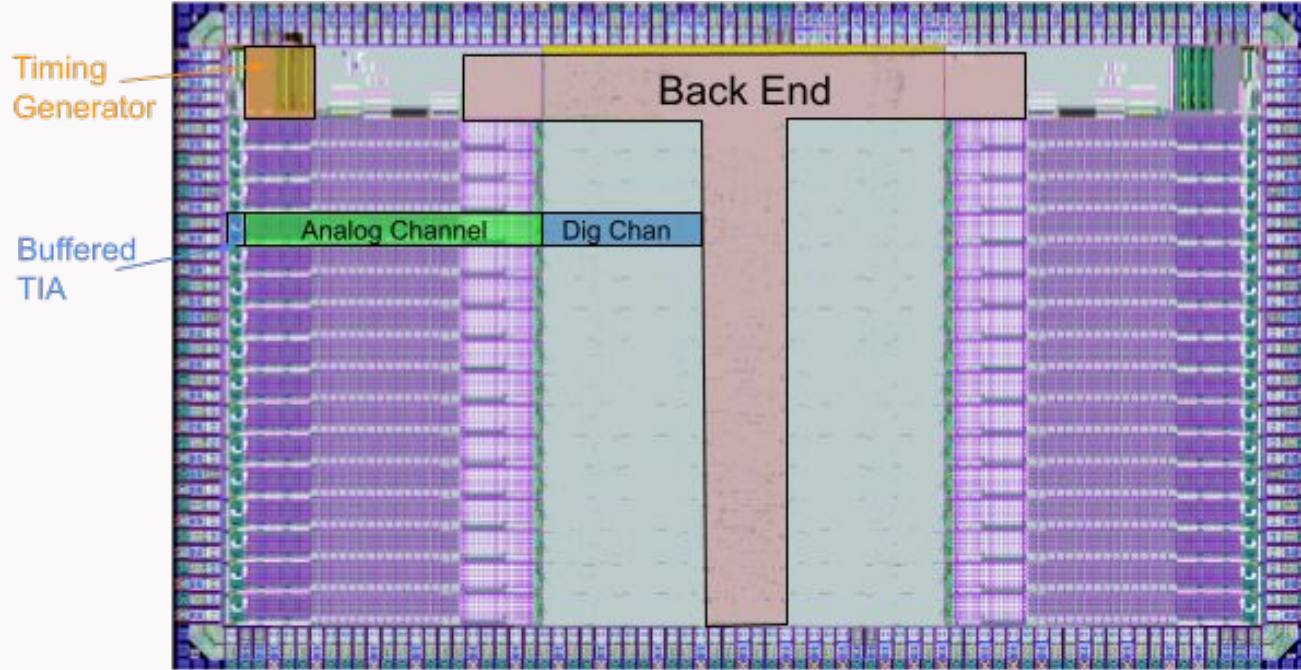


HDSoC v1 die shot

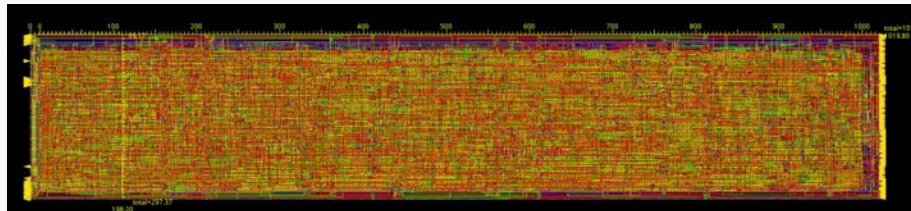
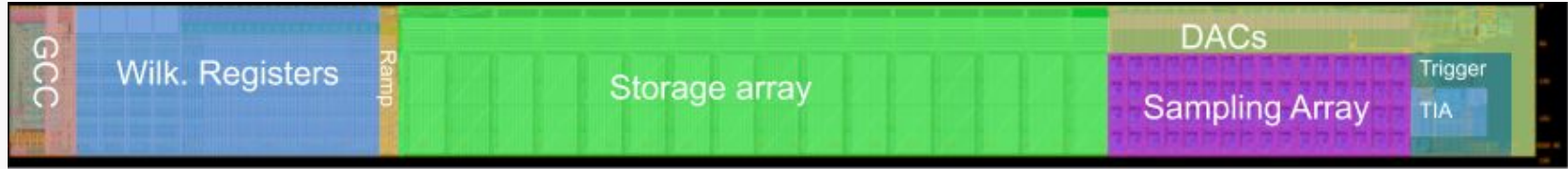


HDSoC v2 die shot

# HDSoC Rev. 1 Layout - 32 ch proto



# HDSoc Rev. 1 Channel Layout (Mixed signal and digital control)



# HDSoC Rev. 1 Package

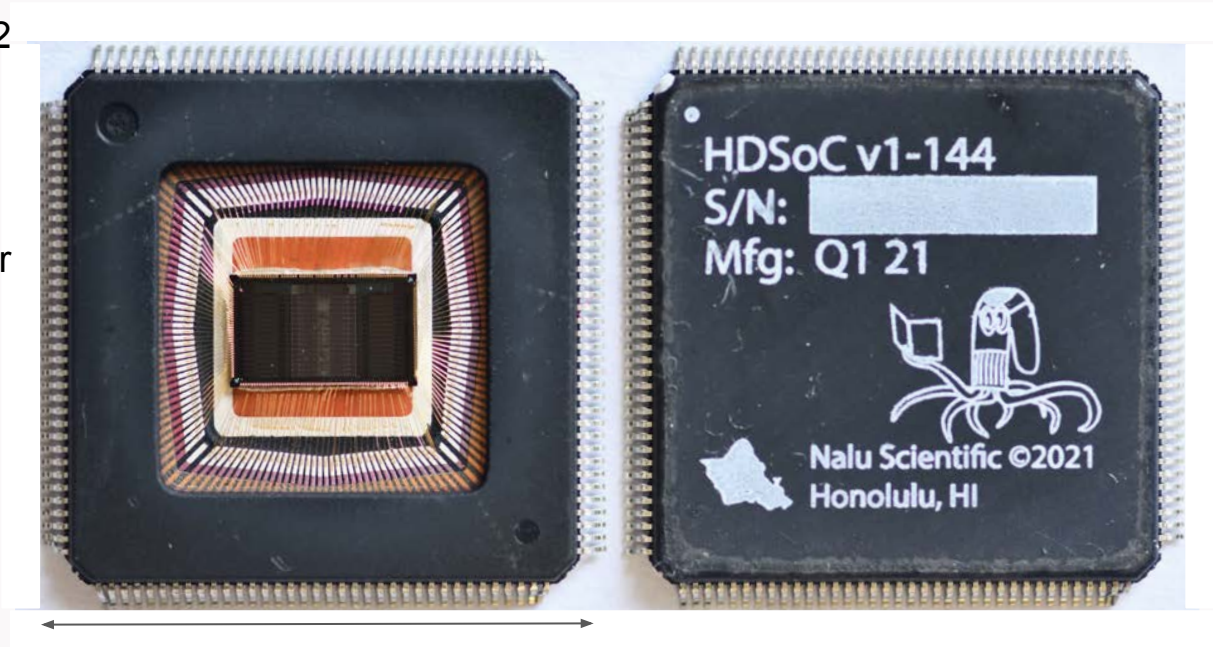
Packaged in QFP144 (22 mm side)

All I/Os connected:

- Serial IF
- Parallel IF

After validation, a smaller package (LQFP128 - 16mm side) with only serial interface can be used. 144 pins are sufficient for the 64 channel device.

A custom package could be used to reduce the footprint.



22mm

# Part II: High Density Digitizer SoC Revision 1 Testing

# HDSoc v1 specs

Specifications	
Sampling Rate	1-2 GSPS
ABW	0.6GHz
Depth/channel	2048 Samples
Trigger Buffer	~2 us
Max rate	14kHz/all channels 220 kHz/hits
Channels	32
Supply/Range	2.5V/0.5-2.0V
ADC bits (stated res.)	12
Timing accuracy	<90ps
Technology	250 nm CMOS
Serial Interface	500MHz
Power	47mW/ch

# and Measurements

Confirmed at 1-1.5 GSPS

Measured

Maximal including header and 8b10b encoding overheads - assumes full readout of 1 window (32 samples) and operation at maximum speed for serial interface (500 Mb/s) and system clock (125 MHz) - current tested limit 13.2kHz @312.5MHz serial interface and 31.25MHz system clock.

Linear range with ~5 ADC count sigma = 0.8-2.0V

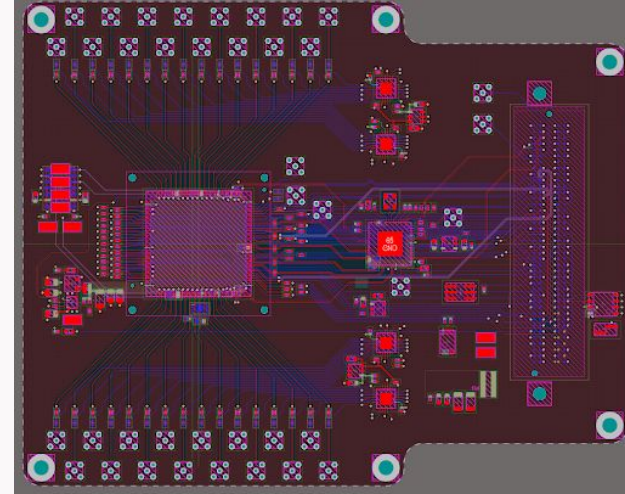
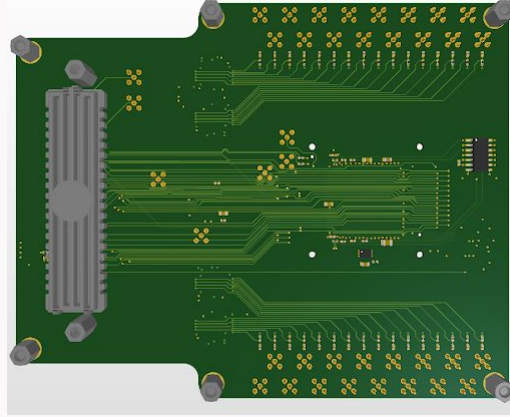
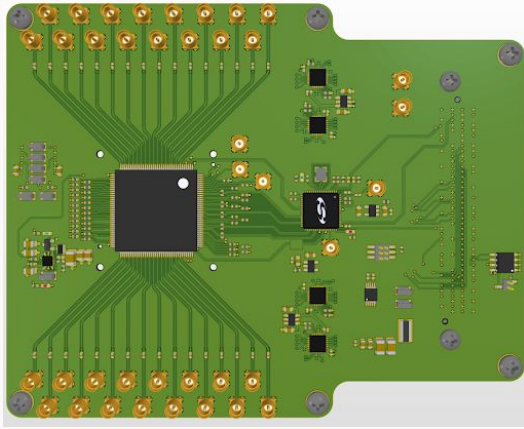
Measured with pulses - currently testing with SiPM

Measured to 312.5MHz

Some sources of extra power identified - reduced in V2

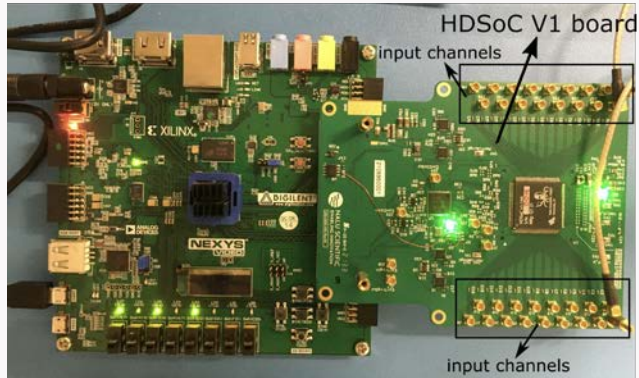
Includes: sensor bias, amplifier, trigger, data transfer.

# Test boards Design



- All 32 channels accessible via MMCX connectors
  - Individual channel biasing
- On board clock generation
- Interface to readout board via standard FMC connector
  - Permits testing of all modes, including serial interface

# Test boards setup



Evaluation Board - now available to interested customers through CAEN - connects to inexpensive readout board with Ethernet connectivity

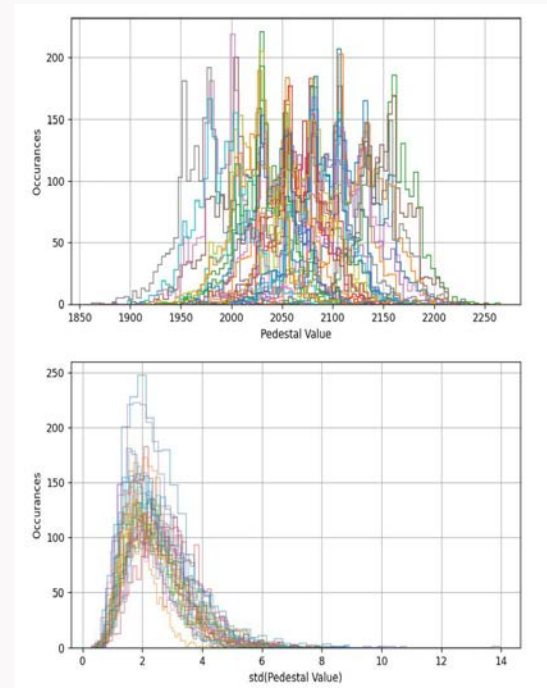
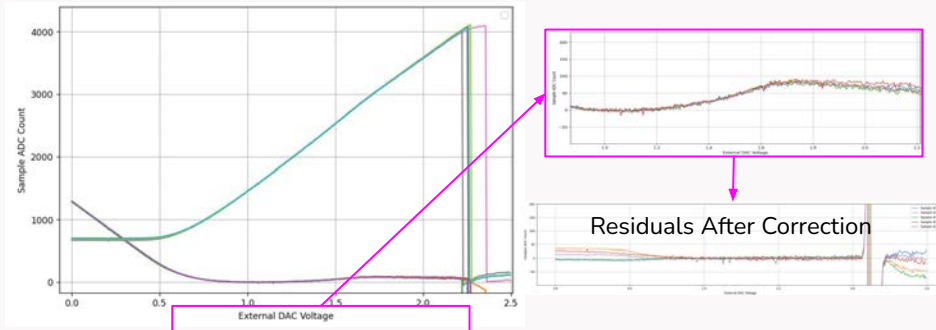


Test Rig at Nalu - full remote access to boards, including signal sources - a lifesaver during COVID days....



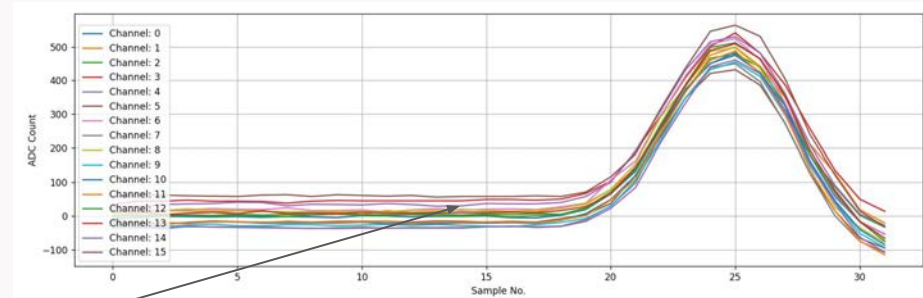
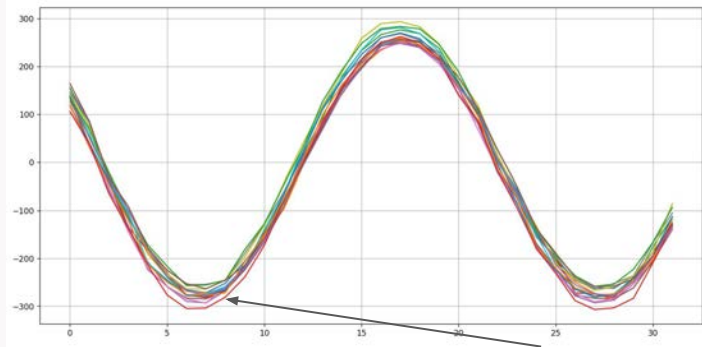
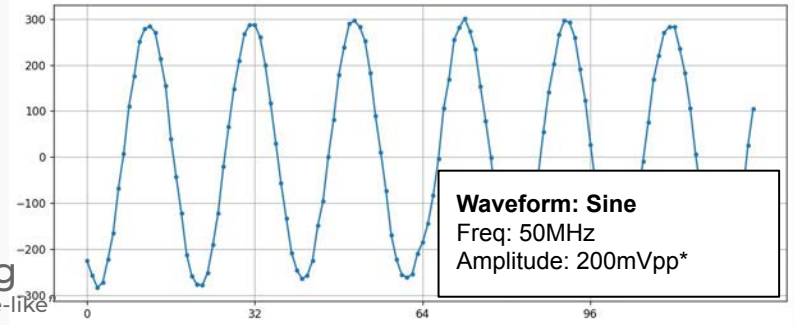
# HDSocv1 Static accuracy

- “Pedestal” evaluation:
  - Due to internal offsets the individual sample values need to be calibrated
  - Statistics on the individual readout for the calibration can be used to estimate the “static error” at bias level -> ~2 ADC count standard deviation
- Varying the input bias to the chip allows studying the overall non-linearity of the conversion - pattern can be calibrated in a large range (1.2V) with residual of ~5 ADC counts (3 ADC counts for a central range of ~200mV)



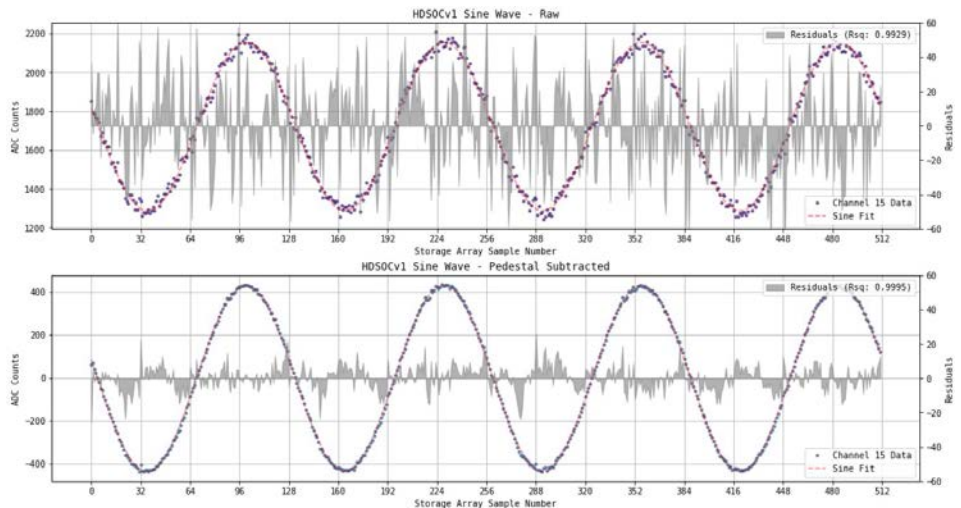
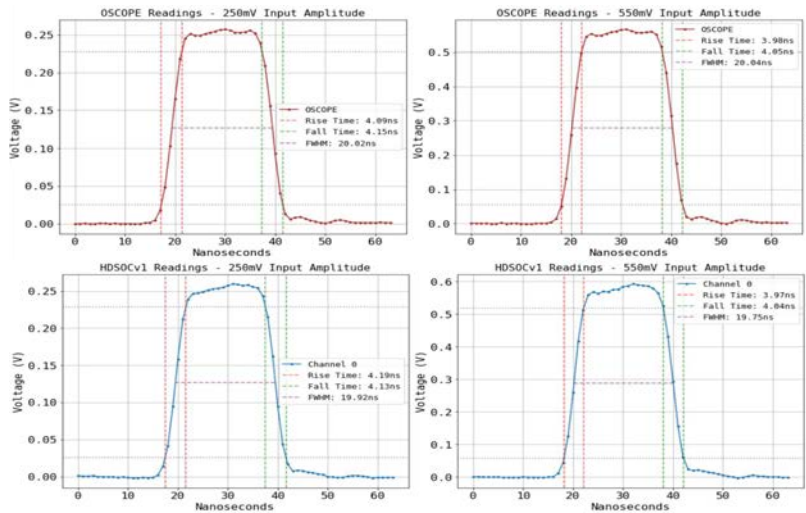
# Waveform collection

- **Waveform collection, initial calibration**
  - Single channel acquisition
  - Sine wave input case
  - Proper timing ("stitching") across windows
  - First order amplitude calibration
  -
- **Multi-channel: synchronized data taking**
  - Same signal split into multiple channels (sine and "pulse-like events)



Signal drift resolved - issue with board biasing network

# Square Pulse and Sine wave Response



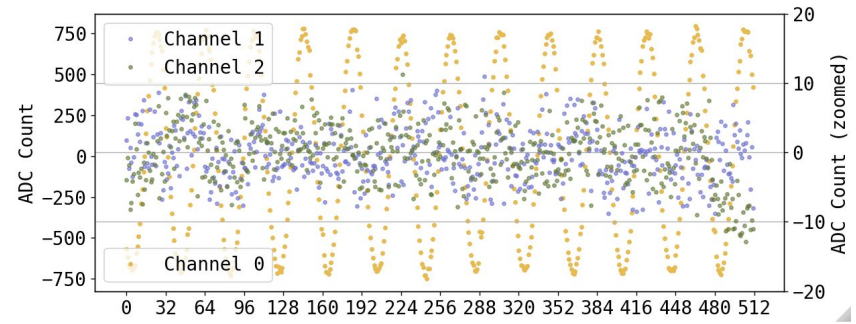
Comparison of square waves captured on an oscilloscope and on a HDSoC channel, with general shape and key parameters (rise time/width/delays) well preserved

Voltage calibration (Pedestal subtracted) corrects major errors, as shown by wave fitting, though residuals are still present.

# Crosstalk: Pulse and Sine Wave Inputs

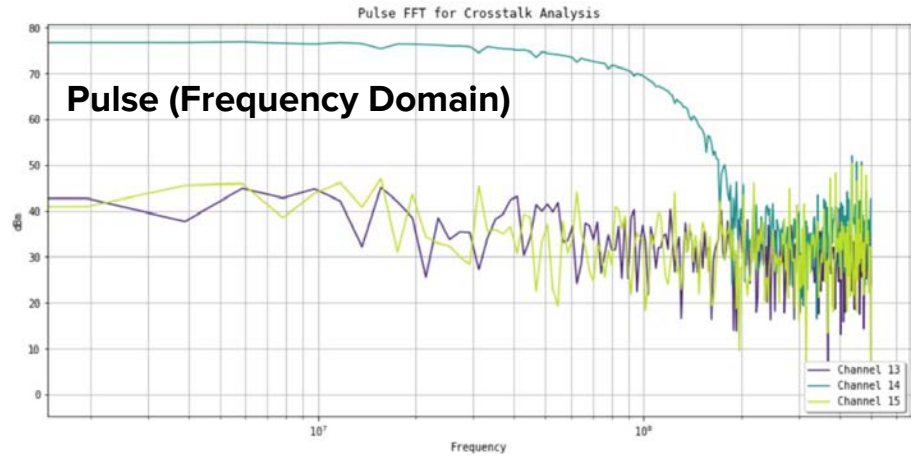
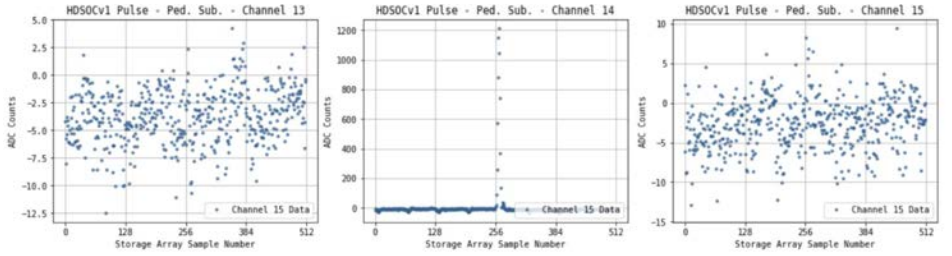
No signs of significantly visible crosstalk on neighbor channels

## Sine Wave



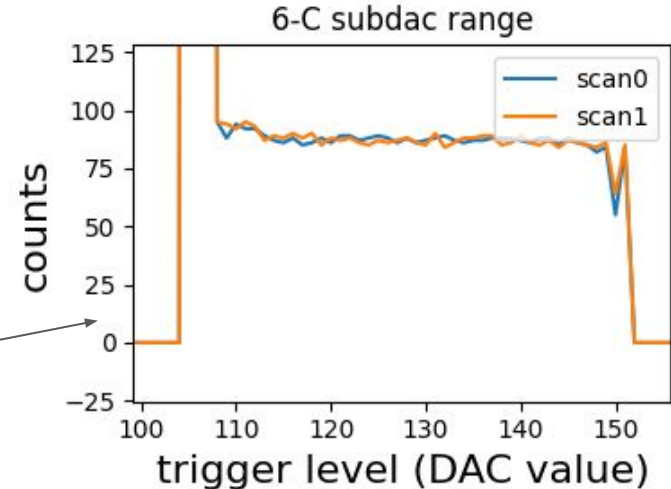
Note: signal and noise on difference scales

## Pulse (Time Domain)



# Digital Partition Features testing

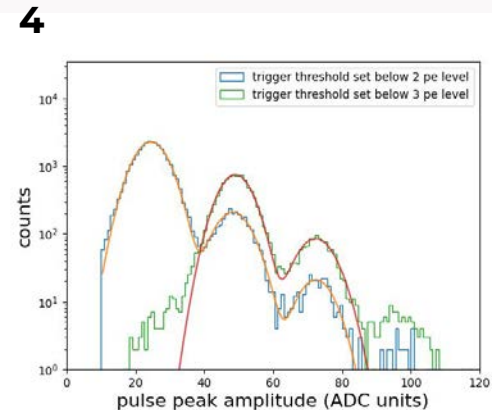
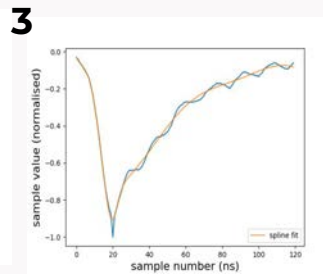
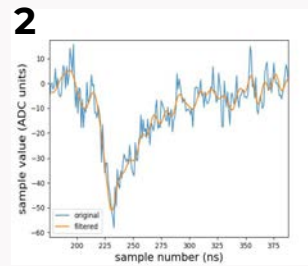
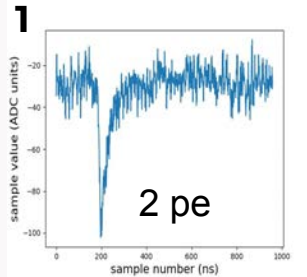
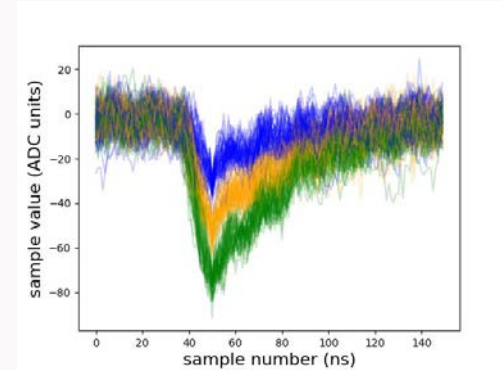
- Different acquisition modes (ROI, self-triggering)
  - Self triggering
  - RoI (zero suppression based on internal thresholds)
- Max sampling rate -> data to 1.5
- Verification of output trigger streaming
- Internal Scalers to perform threshold scans
- Serial interface (functionality and speed)
- Max event rate: 14kEvents/s for all channel readout, 220kEv/s for single channel



# SiPM readout experiments

HDSoc V1 connected to a SiPM array. Onsemi J-Series 4x4 array of 3 x 3 mm<sup>2</sup> SiPMs. HDSoc V1 channel 0 was set to trigger on signals corresponding to two PEs and above

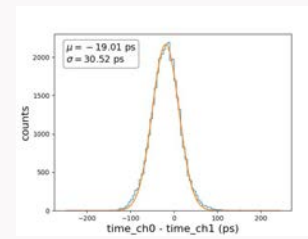
1. SiPM pulses acquired via HDSoc self-triggering capability
2. SiPM pulse template (via averaging) calculated.  
A spline fit was used to smooth the averaged pulse.
3. Template fit to estimate the amplitude of the pulse peak.
4. Pulse peak histogram shows maxima for 2 PE, 3 PE depending on the trigger threshold - (2, 3 and 4 PEs resolved at  $24.4 \pm 4.7$ ,  $48.2 \pm 4.9$  and  $72.3 \pm 4.7$  ADC units)



# Timing Measurements and calibration

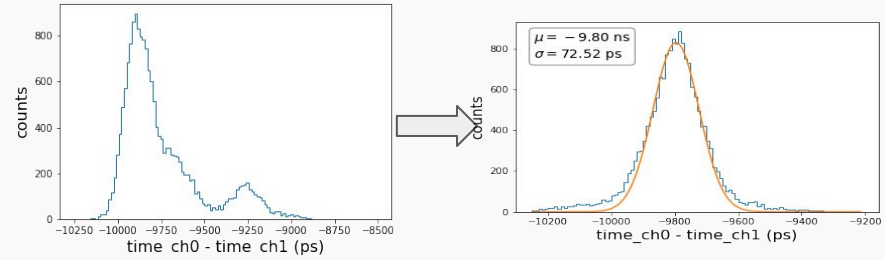
## Estimating timing accuracy:

1. Identical Split pulse to two channels: ~30ps - (100 MHz 450 mV unipolar sine burst)

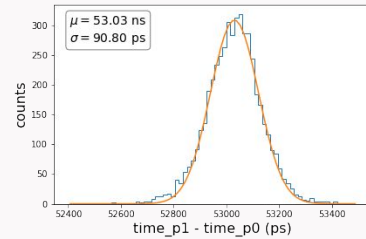


2. Intra-channel accuracy: signal delayed ~10ns: with timing calibration ~72ps

Note: Timing calibration performed using bin-occupancy fraction method on channels 0 and 1



3. Inter-channel accuracy with “far” signals and timing calibration ~90ps



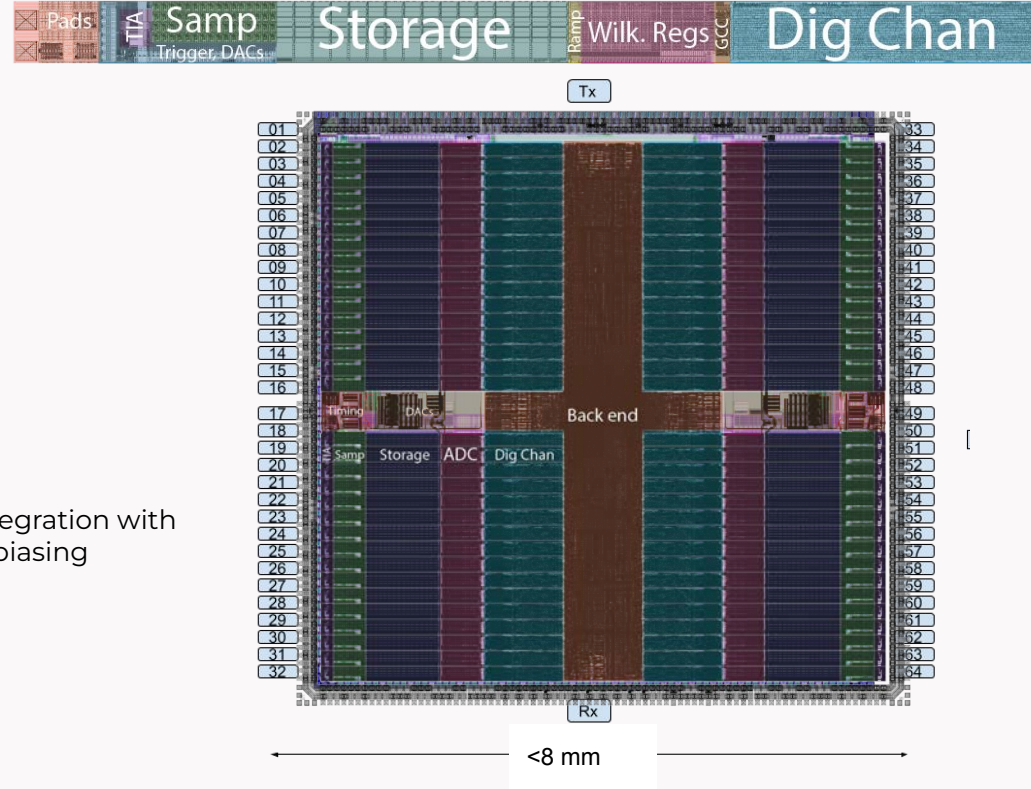
Part III:  
High Density Digitizer SoC Revision 2  
Design and Fabrication



# HDSocv2 design

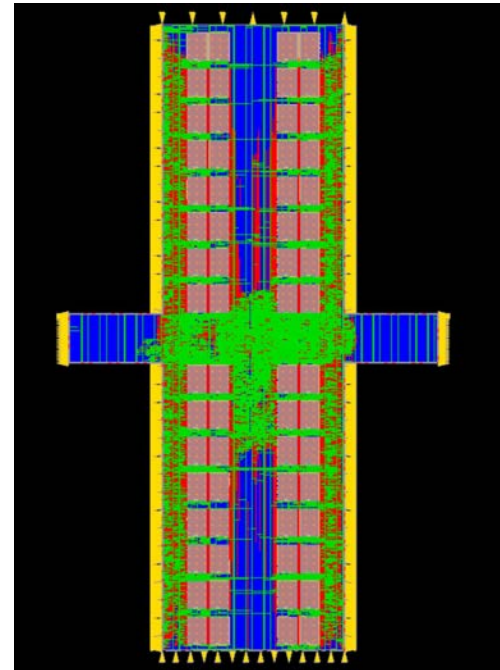
- HDSocv2

- Main improvements:
  - 64 channel device
  - Proper timing up to 2 GSPS
  - Reduced power consumption/chan
    - DAC uniformity
    - Clock gating
    - Triggering and Scalers reduction
  - Improved TIA
    - Correct low BW issue (input stage)
    - Complete redesign to target better integration with SiPMs, controllable internal and SiPM biasing
  - Improved signal quality:
    - Analog/digital isolation
    - Biasing control (current- based)
    - Comparator biasing
    - Power domain separation

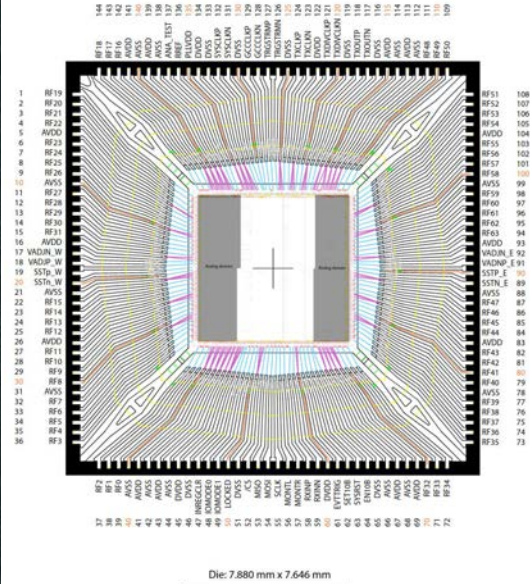
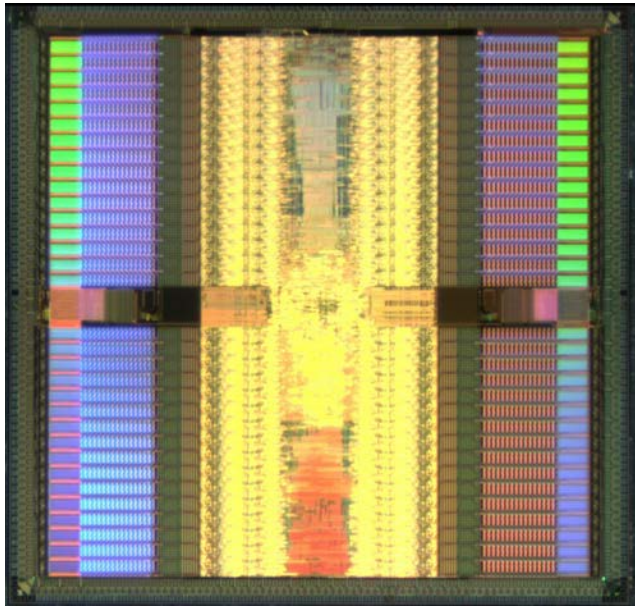


# HDSocv2 - digital Improvements

- PLL for internal generation of clocks:
  - Only one reference clock required for sampling, conversion, readout
- Simplified SPI-like interface for configuration:
  - Rev. 1 - fast LVDS proprietary interface (still available)
  - Rev. 2 - slower single-ended and simpler interface with chaining to reduce system constraints
- Design of internal calibrations SRAM and Feature extraction mechanism to reduce rates - not included in production due to scheduling constraints, but available for next revision.
- Some minor corrections:
  - Added Header information for ROI mode.
  - The internal scalers changes to avoid double counting
  - Added programmable masking for channel
  - External triggering changed from level trigger to edge trigger to simplify the system level requirements.
  - Command to trigger and request a single event



# HDSoc v2 Layout - Fabricated die



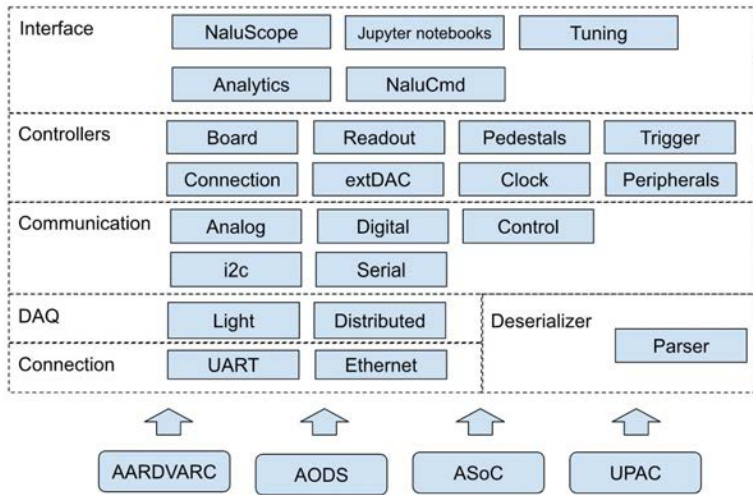
Die: 7.880 mm x 7.646 mm

HDSoc V2 QFP 144 (0.5mm pitch)

20mm

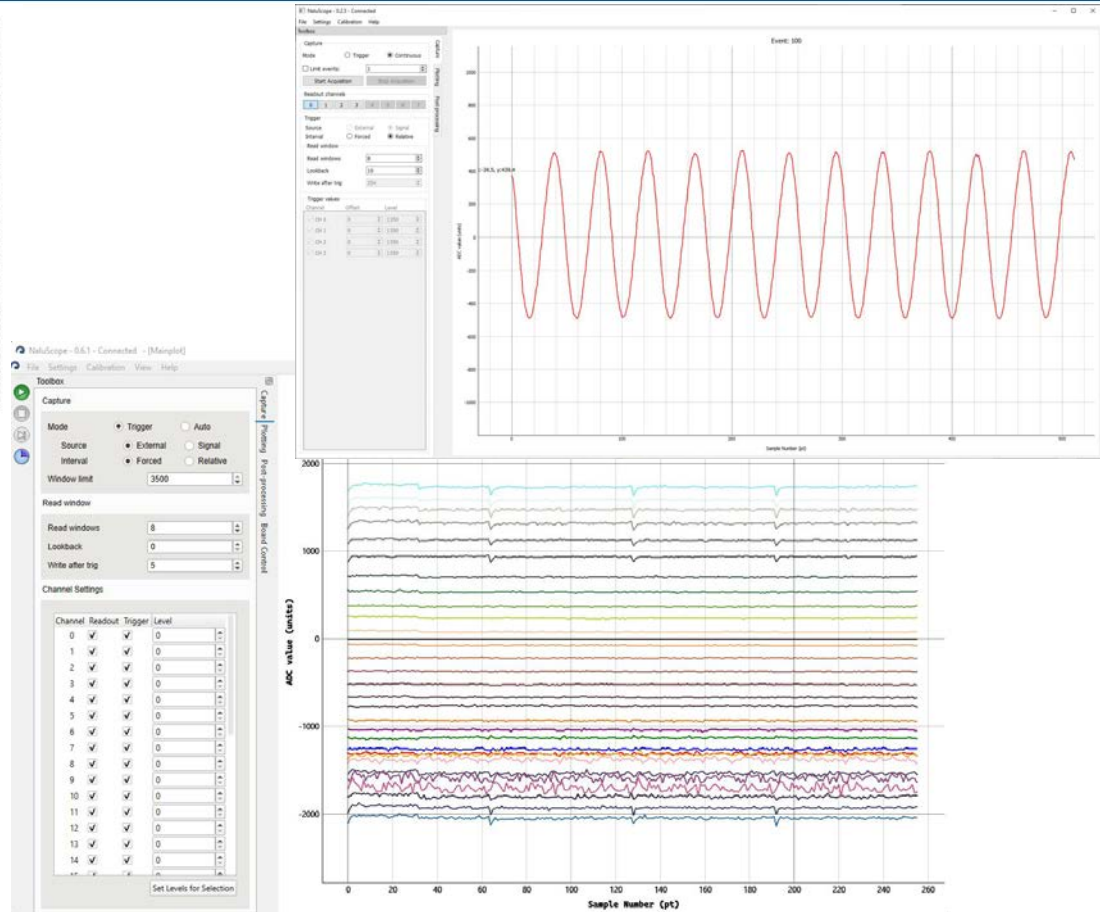


# NaluScope Common Software and GUI



The Nalu software is built around reusable modules, allowing multiple use cases and UIs.

- Windows/Linux PC
- USB interface
- 1GB Ethernet
- GUI, CLI interfaces
- Common to all Nalu chips
- DAQ configuration
- Data exploration, visualization, curation and storage



# Conclusions and future work

- **HDSoc v1**
  - All channels functional
  - Proper multi-window, multi-channel acquisition, self triggering, output streaming
  - Some issues with noise and power/ TIA BW
  - Test boards available through our U.S. distributor, CAEN - together with FW/SW/GUI and support.
- **HDSoc v2**
  - Fabricated - currently gearing up for testing
  - HDSoc v1/2 may be used in beam tests for various EIC sub detectors
  - Opportunity to implement EIC specific (sensor, backend) needs in future revisions or branches
- **HDSoc is a novel streaming readout capable, waveform- sampling ASIC:**
  - Low Cost, low power, scalable
  - Works with a variety of sensors arrays: GEMS, TPCs, SiPMs, MA/PMTs, MCP PMTs
  - Tracking and PID
  - Portable radiation imaging systems
  - Compact, high-efficiency neutron scatter cameras for non-proliferation national security missions.
- Various conference presentations and live demos

# ACKNOWLEDGEMENTS

US Department of Energy Office of Science

Hawaii Technology Development Corporation (HTDC)

University of Hawai'i at Manoa Department of Physics -  
In Particular the Late Prof. Gary Varner